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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







BLF188XRG

Power LDMOS transistor

Rev. 2 — 1 September 2015



1. Product profile

1.1 General description

A 1400 W extremely rugged LDMOS power transistor for broadcast and industrial applications in the HF to 600 MHz band.

Table 1. Application information

Test signal	f	V _{DS}	PL	Gp	η _D
	(MHz)	(V)	(W)	(dB)	(%)
CW	108	50	1200	26.5	83
pulsed RF	108	50	1400	28	72
pulsed RF	81.4	50	1200	25.8	85

1.2 Features and benefits

- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (HF to 600 MHz)
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications

2. Pinning information

Table 2. Pinning

Pin	Description		Simplified outline	Graphic symbol
1	drain1			
2	drain2			
3	gate1			3
4	gate2		3 4	5
5	source	[1]		2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2
				sym117

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	me Description Version			
BLF188XRG	-	earless flanged LDMOST ceramic package; 4 leads	SOT1248C		

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	135	V
V_{GS}	gate-source voltage		-6	+11	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C

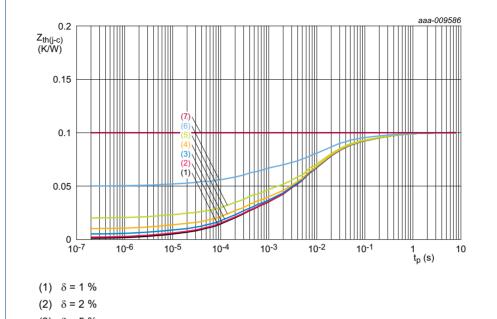
Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions		Тур	Unit
R _{th(j-c)}	thermal resistance from junction to case	$T_j = 150 ^{\circ}\text{C}$][2]	0.10	K/W
Z _{th(j-c)}	transient thermal impedance from junction to case	T_j = 150 °C; t_p = 100 μs; $δ$ = 20 %	[3]	0.03	K/W

- [1] T_j is the junction temperature.
- [2] R_{th(j-c)} is measured under RF conditions.
- [3] See Figure 1.



- (3) $\delta = 5 \%$
- (4) $\delta = 10 \%$
- (5) $\delta = 20 \%$
- (6) $\delta = 50 \%$
- (7) $\delta = 100 \% (DC)$

Fig 1. Transient thermal impedance from junction to case as a function of pulse duration

6. Characteristics

Table 6. DC characteristics

 T_i = 25 °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 5.5 \text{ mA}$	135	-	-	V
V _{GS(th)}	gate-source threshold voltage	V _{DS} = 10 V; I _D = 550 mA	1.25	1.9	2.25	V
V_{GSq}	gate-source quiescent voltage	$V_{DS} = 50 \text{ V}; I_{D} = 20 \text{ mA}$	0.68	1.3	1.8	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 50 \text{ V}$	-	-	2.8	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	77	-	А
I _{GSS}	gate leakage current	V _{GS} = 11 V; V _{DS} = 0 V	-	-	280	nA
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 19.25 A$	-	0.08	-	Ω

Table 7. AC characteristics

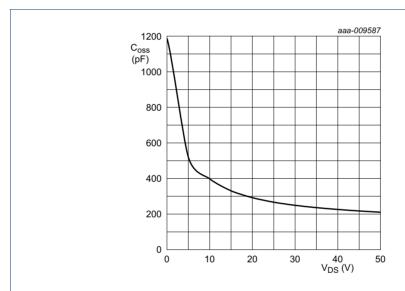
 T_i = 25 °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _{rs}	feedback capacitance	V _{GS} = 0 V; V _{DS} = 50 V; f = 1 MHz	-	6.2	-	pF
C _{iss}	input capacitance	V _{GS} = 0 V; V _{DS} = 50 V; f = 1 MHz	-	582	-	pF
C _{oss}	output capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 50 \text{ V}; f = 1 \text{ MHz}$	-	212	-	pF

Table 8. RF characteristics

Test signal: pulsed RF; $t_p = 100 \ \mu s$; $\delta = 20 \ \%$; $f = 108 \ MHz$; RF performance at $V_{DS} = 50 \ V$; $I_{Da} = 40 \ mA$; $T_{case} = 25 \ ^{\circ}C$; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	P _L = 1400 W	23.2	24.4	-	dB
RLin	input return loss	P _L = 1400 W	-	-21	-14	dB
η_{D}	drain efficiency	P _L = 1400 W	69	73	-	%



 $V_{GS} = 0 V$; f = 1 MHz.

Fig 2. Output capacitance as a function of drain-source voltage; typical values per section

7. Test information

7.1 Ruggedness in class-AB operation

The BLF188XRG is capable of withstanding a load mismatch corresponding to VSWR > 65 : 1 through all phases under the following conditions: V_{DS} = 50 V; I_{Dq} = 40 mA; P_{L} = 1400 W pulsed; f = 108 MHz.

7.2 Impedance information

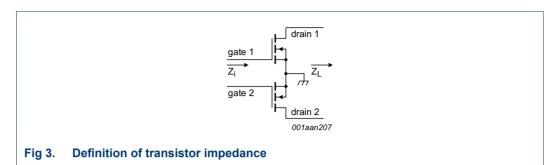


Table 9. Typical push-pull impedance

Simulated Z_i and Z_L device impedance; impedance info at $V_{DS} = 50 \text{ V}$ and $P_L = 1400 \text{ W}$.

f	Z _i	Z_L
(MHz)	(Ω)	(Ω)
108	2.94 – j9.64	2.74 + j0.57

7.3 UIS avalanche energy

Table 10. Typical avalanche data per section

 T_{amb} = 25 °C; typical test data; test jig without water cooling.

E _{AS}
(J)
4.5
3.4
2.4
2.0

For information see application note AN10273.

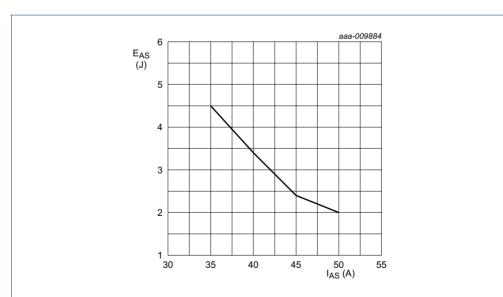
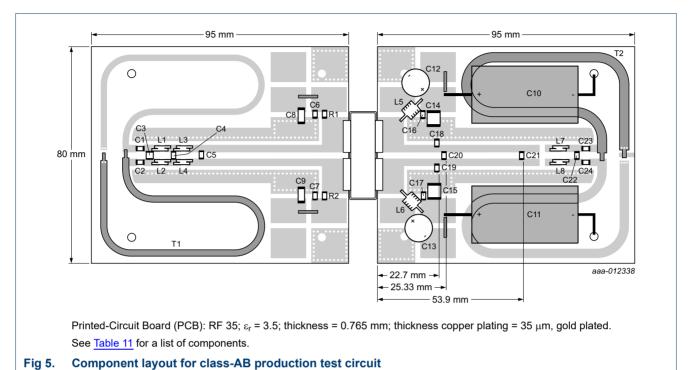


Fig 4. Non-repetitive avalanche energy as a function of single pulse avalanche current, typical values

7.4 Test circuit



g o. Component layout for class-AD production test circle

Table 11. List of components For test circuit see Figure 5.

Component	Description	Value		Remarks
C1, C2, C6, C7, C16, C17, C23, C24	multilayer ceramic chip capacitor	1000 pF	[1]	
C3	multilayer ceramic chip capacitor	47 pF	[2]	
C4	multilayer ceramic chip capacitor	39 pF	[1]	
C5	multilayer ceramic chip capacitor	200 pF	[1]	
C8, C9, C14, C15	multilayer ceramic chip capacitor	4.7 μF, 100 V		TDK C5750X7R2A475KT
C10, C11	electrolytic capacitor	2200 μF, 63 V		
C12, C13	electrolytic capacitor	470 μF, 63 V		
C18, C19	multilayer ceramic chip capacitor	120 pF	[1]	
C20	multilayer ceramic chip capacitor	82 pF	[1]	
C21	multilayer ceramic chip capacitor	120 pF	[1]	
C22	multilayer ceramic chip capacitor	56 pF	[1]	
L1, L2, L3, L4	1.5 turn 0.8 mm copper wire	D = 3.2 mm, length = 1.6 mm		
L5, L6	5.0 turn 0.8 mm copper wire	D = 3.0 mm, length = 4 mm		
L7, L8	2.5 turn 0.8 mm copper wire	D = 3.0 mm, length = 2.4 mm		

Table 11. List of components ...continued For test circuit see Figure 5.

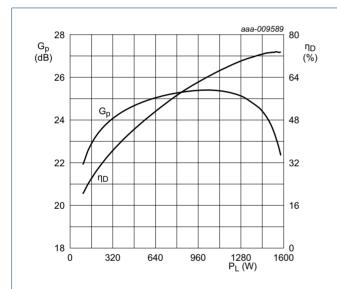
Component	Description	Value	Remarks
R1, R2	resistor	9.1 Ω	SMD 1206
T1	semi rigid coax	25 Ω, length = 160 mm	Micro-Coax UT-090C-25
T2	semi rigid coax	25 Ω, length = 160 mm	Micro-Coax UT-141C-25

- [1] American Technical Ceramics type 800B or capacitor of same quality.
- [2] American Technical Ceramics type 100B or capacitor of same quality.

7.5 Graphical data

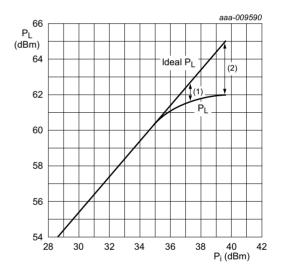
The following figures are measured in a class-AB production test circuit.

7.5.1 1-Tone CW pulsed



 V_{DS} = 50 V; I_{Dq} = 40 mA; f = 108 MHz; t_p = 100 $\mu s;$ δ = 20 %.

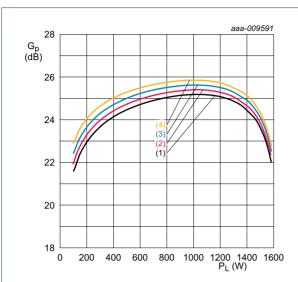
Fig 6. Power gain and drain efficiency as function of output power; typical values



 V_{DS} = 50 V; I_{Dq} = 40 mA; f = 108 MHz; t_p = 100 μs ; δ = 20 %.

- (1) $P_{L(1dB)} = 61.58 \text{ dBm } (1440 \text{ W})$
- (2) $P_{L(3dB)} = 61.98 \text{ dBm } (1580 \text{ W})$

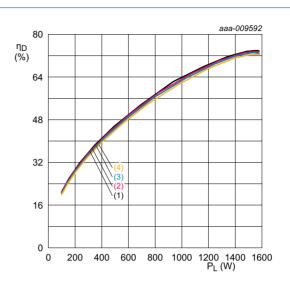
Fig 7. Output power as a function of input power; typical values



 V_{DS} = 50 V; f = 108 MHz; t_p = 100 μ s; δ = 20 %.

- (1) $I_{Dq} = 20 \text{ mA}$
- (2) $I_{Dq} = 40 \text{ mA}$
- (3) $I_{Dq} = 80 \text{ mA}$
- (4) $I_{Dq} = 160 \text{ mA}$

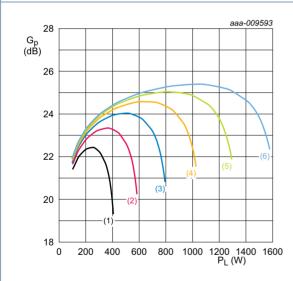
Fig 8. Power gain as a function of output power; typical values



 $V_{DS} = 50 \text{ V}$; f = 108 MHz; $t_p = 100 \text{ } \mu\text{s}$; $\delta = 20 \text{ } \%$.

- (1) $I_{Dq} = 20 \text{ mA}$
- (2) $I_{Dq} = 40 \text{ mA}$
- (3) $I_{Dq} = 80 \text{ mA}$
- (4) $I_{Dq} = 160 \text{ mA}$

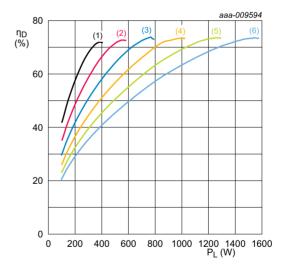
Fig 9. Drain efficiency as a function of output power; typical values



 I_{Dq} = 40 mA; f = 108 MHz; t_p = 100 μ s; δ = 20 %.

- (1) $V_{DS} = 25 \text{ V}$
- (2) $V_{DS} = 30 \text{ V}$
- (3) $V_{DS} = 35 \text{ V}$
- (4) $V_{DS} = 40 \text{ V}$
- (5) $V_{DS} = 45 \text{ V}$
- (6) $V_{DS} = 50 \text{ V}$

Fig 10. Power gain as a function of output power; typical values



 I_{Dq} = 40 mA; f = 108 MHz; t_p = 100 μ s; δ = 20 %.

- (1) $V_{DS} = 25 \text{ V}$
- (2) $V_{DS} = 30 \text{ V}$
- (3) $V_{DS} = 35 V$
- (4) $V_{DS} = 40 \text{ V}$
- (5) $V_{DS} = 45 \text{ V}$
- (6) $V_{DS} = 50 \text{ V}$

Fig 11. Drain efficiency as a function of output power; typical values

8. Package outline

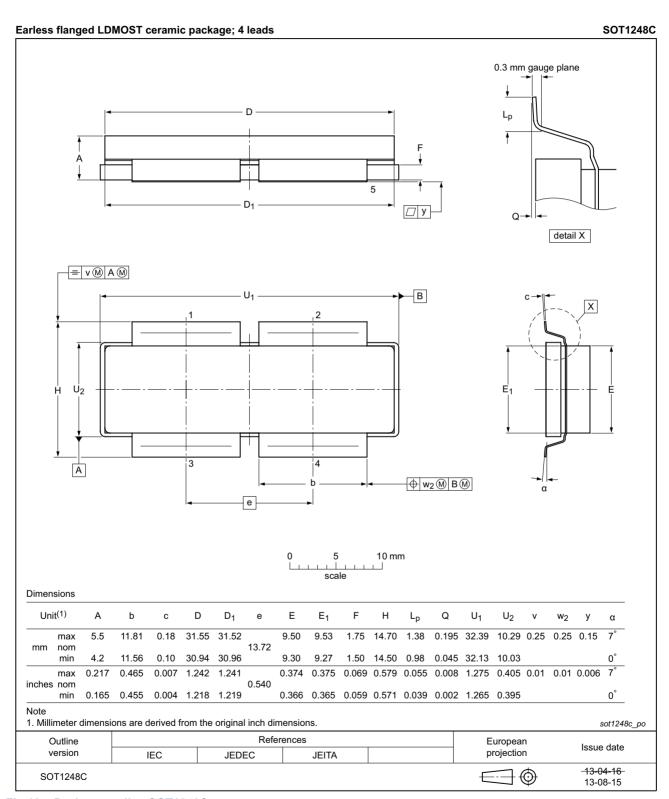


Fig 12. Package outline SOT1248C

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

10. Abbreviations

Table 12. Abbreviations

Acronym	Continuous Wave
CW	Continuous Wave
ESD	ElectroStatic Discharge
HF	High Frequency
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
MTF	Median Time to Failure
SMD	Surface Mounted Device
UIS	Unclamped Inductive Switching
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change not	ice Supersedes		
BLF188XRG#2	20150901	Product data sheet	-	BLF188XRG v.1		
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
BLF188XRG v.1	20140630	Product data sheet	-	-		

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Power LDMOS transistor

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